



## NPN SILICON PLANAR EPITAXIAL TRANSISTOR

## BF199



TO-92 Plastic Package

## **RF Transistor**

DESCRIPTION	SYMBOL	VALUE	UNITS
Collector Emitter Voltage	V <sub>CEO</sub>	25	V
Collector Base Voltage	V <sub>CBO</sub>	40	V
Emitter Base Voltage	V <sub>EBO</sub>	4.0	V
Collector Current Continuous	Ι <sub>C</sub>	100	mA
Power Dissipation @ T <sub>a</sub> =25 <sup>o</sup> C	PD	350	mW
Derate Above 25°C		2.8	mW/ ⁰C
Power Dissipation @ T <sub>c</sub> =25°C	PD	1.0	W
Derate Above 25°C		8.0	mW/ ⁰C
Operating And Storage Junction Temperature Range	T <sub>j</sub> , T <sub>stg</sub>	- 55 to +150	٥C

# THERMAL RESISTANCE

Junction to case	R <sub>th (j-c)</sub>	125	°C/W
Junction to Ambient in free air	R <sub>th (j-a)</sub>	357	°C/W

## ELECTRICAL CHARACTERISTICS (T<sub>a</sub>=25°C unless specified otherwise)

DESCRIPTION	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNITS	
Collector Emitter Voltage	$V_{CEO}$	I <sub>C</sub> =1mA, I <sub>B</sub> =0	25			V	
Collector Base Voltage	V <sub>CBO</sub>	I <sub>C</sub> =100μΑ, I <sub>E</sub> =0	40			V	
Emitter Base Voltage	V <sub>EBO</sub>	I <sub>E</sub> =10μΑ, I <sub>C</sub> =0	4			V	
Collector Cut off Current	I <sub>CBO</sub>	$V_{CB}=20V, I_{E}=0$			100	nA	
DC Current Gain	h <sub>FE</sub>	I <sub>C</sub> =7mA, V <sub>CE</sub> =10V	40				
Base Emitter On Voltage	V <sub>BE (on)</sub>	I <sub>C</sub> =7mA, V <sub>CE</sub> =10V			0.90	V	

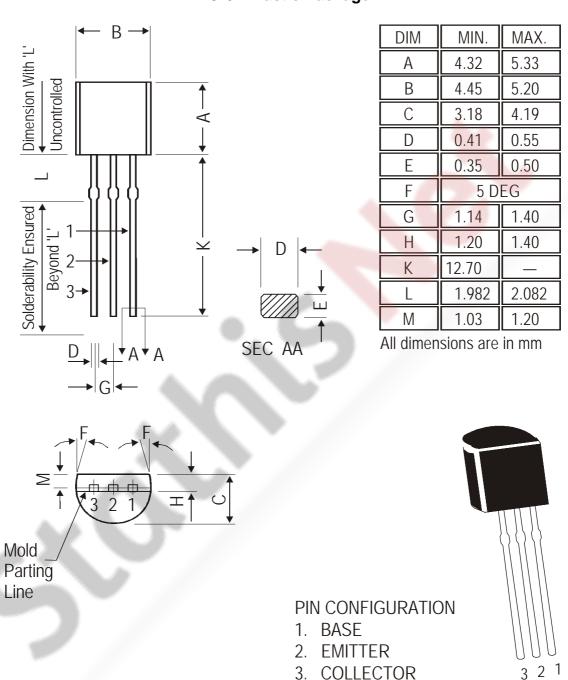
#### **DYNAMIC CHARACTERISTICS**

Transition Frequency	f <sub>T</sub>	$I_C$ =5mA, $V_{CE}$ =10V, f=100MHz	400			MHz
Common Emitter Feedback Capacitance	C <sub>re</sub>	V <sub>CB</sub> =10V, I <sub>E</sub> =0, f=1MHz			0.35	pF
Noise Figure	NF	$I_{C}$ =4mA, $V_{CE}$ =10V, $R_{S}$ =50 $\Omega$ , f=35MHz		2.5		dB

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## **TO-92 Plastic Package**

The TO-92 Package, Tape and Ammo Pack Drawings are correct as on the date of issue/revision of this Data Sheet.

The currently valid dimensions and information, may please be confirmed from the TO-92 Drawing in the Packages and Packing Section of the Product Catalogue.

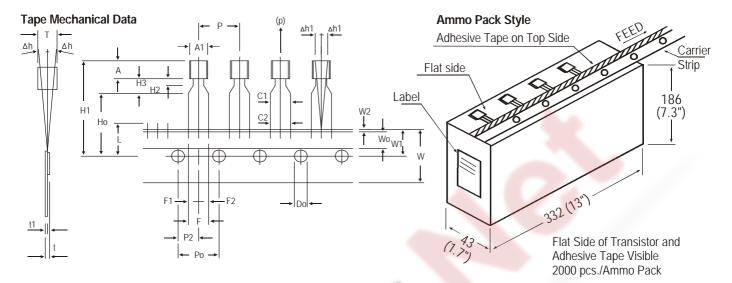
#### **Packing Details**

PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX		
	Details	Net Weight/Qty	Size	Qty	Size	Qty	Gr Wt
TO-92 Bulk	1K/polybag	200 gm/1K pcs	3" x 7.5" x 7.5"	5K	17" x 15" x 13.5"	80K	23 kgs
TO-92 T&A	2K/ammo box	645 gm/2K pcs	12.5" x 8" x 1.8"	2K	17" x 15" x 13.5"	32K	12.5 kgs

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## **TO-92 Tape and Ammo Pack**

#### All dimensions are in mm

IT THE		SPECIFICATION				
ITEM	SYMBOL	MIN.	NOM.	MAX.	TOL.	
BODY WIDTH	A1	4.0		4.8		1
BODY HEIGHT	А	4.8		5.2		
BODY THICKNESS	Т	3.9		4.2		
PITCH OF COMPONENT	Р		12.7		± 1.0	
*1FEED HOLE PITCH	Po		12.7		± 0.3	
* <sup>2</sup> FEED HOLE CENTRE TO COMPONENT CENTRE	P2		6.35		± 0.4	
DISTANCE BETWEEN OUTER LEADS	F		5.08		+ 0.6 - 0.2	
*3 COMPONENT ALIGNMENT SIDE VIEW	∆h		0	1.0		
*4 COMPONENT ALIGNMENT FRONT VIEW			0	1.3		
TAPE WIDTH	W		18		± 0.5	
HOLD-DOWN TAPE WIDTH	Wo		6		± 0.2	!
HOLE POSITION	W1		9		+ 0.7	
					- 0.5	
HOLD-DOWN TAPE POSITION	W2		0.5		± 0.2	0
LEAD WIRE CLINCH HEIGHT	Ho		16		± 0.5	
COMPONENT HEIGHT	H1			23.25		
LENGTH OF SNIPPED LEADS	L			11.0		
FEED HOLE DIAMETER	Do		4		± 0.2	
*5 TOTAL TAPE THICKNESS	t			1.2		
LEAD - TO - LEAD DISTANCE	F1, F2		2.54		+ 0.4	,
STAND OFF	H2	0.45		1.45	- 0.1	
CLINCH HEIGHT	H3			3.0		3
LEAD PARALLELISM	C1 - C2			0.22		;
PULL - OUT FORCE	(p)	6N				,

### NOTES

- 1. Maximum alignment deviation between leads will not to be greater than 0.2mm.
- 2. Maximum non-cumulative variation between tape feed holes shall not exceed 1 mm in 20 pitches.
- Holddown tape will not exceed beyond the edge(s) of carrier tape and there shall be no exposure of adhesive.
- 4. There will be no more than three (3) consecutive missing components in a tape.
- 5. A tape trailer, having at least three feed holes are provided after the last component in a tape.
- 6. Splices should not interfere with the sprocket feed holes.

#### REMARKS

- \*1 Cumulative pitch error 1.0 mm/20 pitch
- \*2 To be measured at bottom of clinch
- \*3 At top of body
- \*4 At top of body
- \*5 t1 0.3 0.6 mm

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#### Disclaimer

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CDIL is a registered Trademark of Continental Device India Limited C-120 Naraina Industrial Area, New Delhi 110 028, India. Telephone + 91-11-2579 6150 Fax + 91-11-2579 9569, 2579 5290 e-mail sales@cdil.com www.cdil.com, www.cdilsemi.com

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